

PRODUCT RELIABILITY REPORT FOR

MAX31865

Maxim Integrated

14460 Maxim Dr. Dallas, TX 75244

Approved by:

Don Lipps Manager, Reliability Engineering

Conclusion:

The following qualification successfully meets the quality and reliability standards required of all Maxim Integrated products:

MAX31865

In addition, Maxim Integrated's continuous reliability monitor program ensures that all outgoing product will continue to meet Maxim's quality and reliability standards. The current status of the reliability monitor program can be viewed at http://www.maximintegrated.com/qa/reliability/monitor.

Device Description:

A description of this device can be found in the product data sheet. You can find the product data sheet at http://www.maximintegrated.com/search/parts.mvp.

Reliability Derating:

The Arrhenius model will be used to determine the acceleration factor for failure mechanisms that are temperature accelerated.

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AfT = exp((Ea/k)*(1/Tu - 1/Ts)) = tu/ts

AfT = Acceleration factor due to Temperature

tu = Time at use temperature (e.g. 55°C)

ts = Time at stress temperature (e.g. 125°C)

k = Boltzmann's Constant (8.617 x 10-5 eV/°K)

Tu = Temperature at Use (°K)

Ts = Temperature at Stress (°K)
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Ea = Activation Energy (e.g. 0.7 ev)

The activation energy of the failure mechanism is derived from either internal studies or industry accepted standards, or activation energy of 0.7ev will be used whenever actual failure mechanisms or their activation energies are unknown. All deratings will be done from the stress ambient temperature to the use ambient temperature.

An exponential model will be used to determine the acceleration factor for failure mechanisms, which are voltage accelerated.

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AfV = exp(B*(Vs - Vu))

AfV = Acceleration factor due to Voltage

Vs = Stress Voltage (e.g. 7.0 volts)

Vu = Maximum Operating Voltage (e.g. 5.5 volts)

B = Constant related to failure mechanism type (e.g. 1.0, 2.4, 2.7, etc.)
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The Constant, B, related to the failure mechanism is derived from either internal studies or industry accepted standards, or a B of 1.0 will be used whenever actual failure mechanisms or their B are unknown. All deratings will be done from the stress voltage to the maximum operating voltage. Failure rate data from the operating life test is reported using a Chi-Squared statistical model at the 60% or 90% confidence level (Cf).

The failure rate, Fr, is related to the acceleration during life test by:

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Fr = X/(ts * AfV * AfT * N * 2)
X = Chi-Sq statistical upper limit
N = Life test sample size
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Failure Rates are reported in FITs (Failures in Time) or MTTF (Mean Time To Failure). The FIT rate is related to MTTF by:

MTTF = 1/Fr

NOTE: MTTF is frequently used interchangeably with MTBF.

The calculated failure rate for this device/process is:

FAILURE RATE: MTTF (YRS): 2820 FITS: 40.5

DEVICE HOURS: 22636011 FAILS: 0

Only data from Operating Life or similar stresses are used for this calculation.

The parameters used to calculate this failure rate are as follows:

Cf: 60% Ea: 0.7 B: 0 Tu: 25 °C Vu: 3.7 Volts

The reliability data follows. At the start of this data is the device information. The next section is the detailed reliability data for each stress. The reliability data section includes the latest data available and may contain some generic data. **Bold** Product Number denotes specific product data.

Device Information:

Process: Maxim SA Fab S45

Passivation: SiN/SiO2
Die Size: 137 x 120
Number of Transistors: 39837

Interconnect: Aluminum / 0.5% Copper

Gate Oxide Thickness: 140Å

DESCRIPTION DATE CODE/PRODUCT/LOT CONDITION READPOIN QTY FAILS ESD SENSITIVITY 1231 MAX31865 ZJ381729AB- JESD22-A114 HBM 500 VOLTS 1 PUL'S 5 0 ESD SENSITIVITY 1231 MAX31865 ZJ381729AB- JESD22-A114 HBM 1500 VOLTS 1 PUL'S 5 0 ESD SENSITIVITY 1231 MAX31865 ZJ381729AB- JESD22-A114 HBM 2500 VOLTS 1 PUL'S 5 0 ESD SENSITIVITY 1231 MAX31865 ZJ381729AB- JESD22-A114 HBM 2500 VOLTS 1 PUL'S 5 0 ESD SENSITIVITY 1231 MAX31865 ZJ381729AB- JESD22-A114 HBM 2500 VOLTS 1 PUL'S 5 0 ESD SENSITIVITY 1231 MAX31865 ZJ381729AB- JESD22-A114 HBM 2500 VOLTS 1 PUL'S 5 0	ESD HBM									
VOLTS ESD SENSITIVITY 1231 MAX31865 ZJ381729AB- JESD22-A114 HBM 1000 1 PUL'S 5 0 VOLTS ESD SENSITIVITY 1231 MAX31865 ZJ381729AB- JESD22-A114 HBM 1500 1 PUL'S 5 0 VOLTS ESD SENSITIVITY 1231 MAX31865 ZJ381729AB- JESD22-A114 HBM 2000 1 PUL'S 5 0 VOLTS ESD SENSITIVITY 1231 MAX31865 ZJ381729AB- JESD22-A114 HBM 2500 1 PUL'S 5 0 VOLTS	DESCRIPTION	DATE	CODE/PRODUCT/	/LOT	CONDITION	READ	POIN	QTY	FAILS	FA#
VOLTS ESD SENSITIVITY 1231 MAX31865 ZJ381729AB- JESD22-A114 HBM 1500 1 PUL'S 5 0 ESD SENSITIVITY 1231 MAX31865 ZJ381729AB- JESD22-A114 HBM 2000 1 PUL'S 5 0 VOLTS ESD SENSITIVITY 1231 MAX31865 ZJ381729AB- JESD22-A114 HBM 2500 1 PUL'S 5 0 VOLTS	ESD SENSITIVITY	1231	MAX31865	ZJ381729AB-		1	PUL'S	5	0	
VOLTS ESD SENSITIVITY 1231 MAX31865 ZJ381729AB- JESD22-A114 HBM 2000 1 PUL'S 5 0 VOLTS ESD SENSITIVITY 1231 MAX31865 ZJ381729AB- JESD22-A114 HBM 2500 1 PUL'S 5 0 VOLTS	ESD SENSITIVITY	1231	MAX31865	ZJ381729AB-		1	PUL'S	5	0	
VOLTS ESD SENSITIVITY 1231 MAX31865 ZJ381729AB- JESD22-A114 HBM 2500 1 PUL'S 5 0 VOLTS	ESD SENSITIVITY	1231	MAX31865	ZJ381729AB-		1	PUL'S	5	0	
VOLTS	ESD SENSITIVITY	1231	MAX31865	ZJ381729AB-		1	PUL'S	5	0	
Total: 0	ESD SENSITIVITY	1231	MAX31865	ZJ381729AB-		1	PUL'S	5	0	
						Total:			0	

LATCH-UP								
DESCRIPTION	DATE	CODE/PRODUCT/	LOT	CONDITION	READPOIN	QTY	FAILS	FA#
LATCH-UP I	1231	MAX31865	ZJ381729AB-	JESD78A, I-TEST 25C 100mA		6	0	
LATCH-UP I	1231	MAX31865	ZJ381729AB-	JESD78A, I-TEST 25C 250mA		6	0	
LATCH-UP V	1231	MAX31865	ZJ381729AB-	JESD78A, V-SUPPLY TEST 25C		6	0	
					Total:		0	

OPERATING LIFE		
DESCRIPTION	DATE CODE/PRODUCT/LOT CONDITION	READPOIN QTY FAILS FA#
HIGH TEMP OP LIFE	0943 MAX31190 WJ051035AB 125C, 3.6 VOL	TS 192 HRS 45 0
HIGH TEMP OP LIFE	1105 DS3920 ZJ163071AB 135C, 75V (V8	3) 192 HRS 77 0
HIGH TEMP OP LIFE	1218 MAX31910 ZJ276928FA 135C, 36V (V8	3) 192 HRS 80 0
HIGH TEMP OP LIFE	1231 MAX31865 ZJ381729AB- 125C, 3.7V (PS	SA) 192 HRS 80 0
		Total: 0
FAILURE RATE:	MTTF (YRS): 2820 FIT	S: 40.5
	DEVICE HOURS: 22636011 FAIL	S: 0

Cumulative monitor data for the S4 Process results in a FIT Rate of 0.13 @ 25C and 2.31 $\,$ 55C (0.8 eV, 60% UCL).